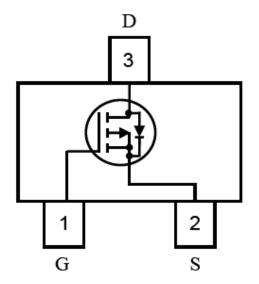


P-Channel MOSFET MEM2303M3

General Description

MEM2303M3G Series P-channel enhancement mode field-effect transistor ,produced with high cell density DMOS trench technology, which is especially used to minimize on-state resistance. This device particularly suits low voltage applications, and low power dissipation, and low power dissipation in a very small outline surface mount package.

Pin Configuration



Features

• -30V/-4.2A

 $R_{DS(ON)} = 55m\Omega @ V_{GS} = -10V, I_D = -4.2A$

 $R_{DS(ON)}$ =62m Ω O V_{GS} =-4.5 V, I_D =-4 A

 $R_{DS(ON)} = 72m\Omega \otimes V_{GS} = -2.5V, I_{D} = -1A$

- High Density Cell Design For Ultra Low On-Resistance
- Subminiature surface mount package:SOT23-3L

Typical Application

- Power management
- Load switch
- Battery protection

Absolute	Maximum	Ratings
----------	---------	---------

I	Parameter	Symbol	Ratings	Unit
Drain-	Source Voltage	V _{DSS}	-30V	V
Gate-	Source Voltage	V _{GSS}	±12	V
Drain	T _A =25℃	- I _D -	-4.2	•
Current	T _A =70℃		-3.5	A
Pulsed	l Drain Current ^{1,2}	I _{DM}	-30	A
Total Power	T _A =25℃	D	1.4	W
Dissipation	$\begin{array}{c c} \hline & & \\ \hline \\ \text{ssipation} & & \\ \hline \\ T_{\text{A}} = 70 ^{\circ} \text{C} & \\ \end{array} \qquad \qquad$	1	٧V	
Operating	Temperature Range	T _{Opr}	150	°C
Storage T	emperature Range	T _{stg}	-65/150	°C



Thermal Characteristics

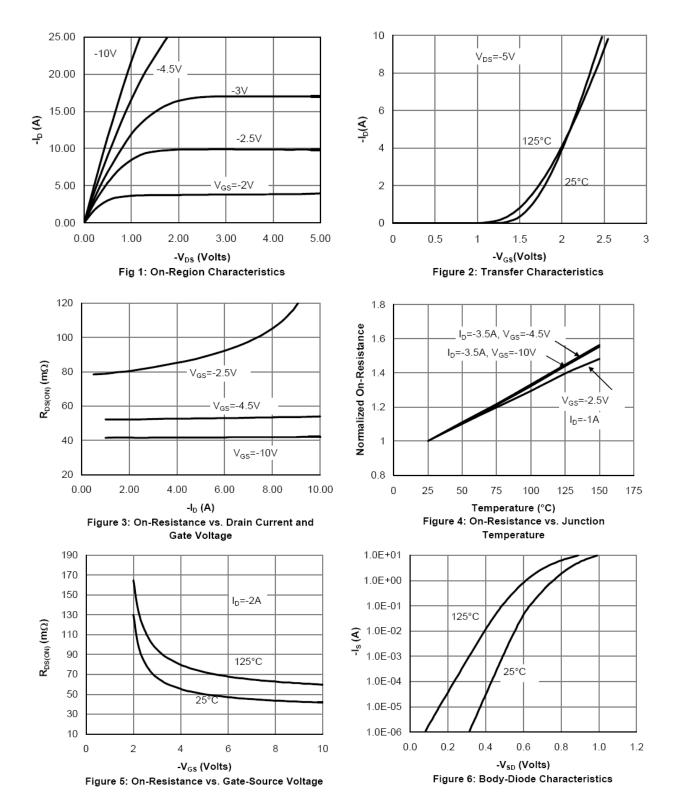
MAX. 90 125 60	Unit °C/W °C/W
125	
125	
	°C /W
	$\bigcirc 7$ V
60	C/VV
00	°C W
00	
Мах	Unit
-	V
-1.3	V
100	nA
-100	nA
-1000	nA
63	mΩ
70	mΩ
90	mΩ
-	S
-22	А
-2.2	~
-10	V
1.0	v
	1
-	pF
-	
-	
-	Ω
-	
-	ns
-	
-]
-	nc
-	
_	
	- -1.3 100 -100 -1000 63 70 90 - - -2.2 -1.0 - - - - - - - - - - - - - - - - - - -

1. Pulse width limited by Max. junction temperature.

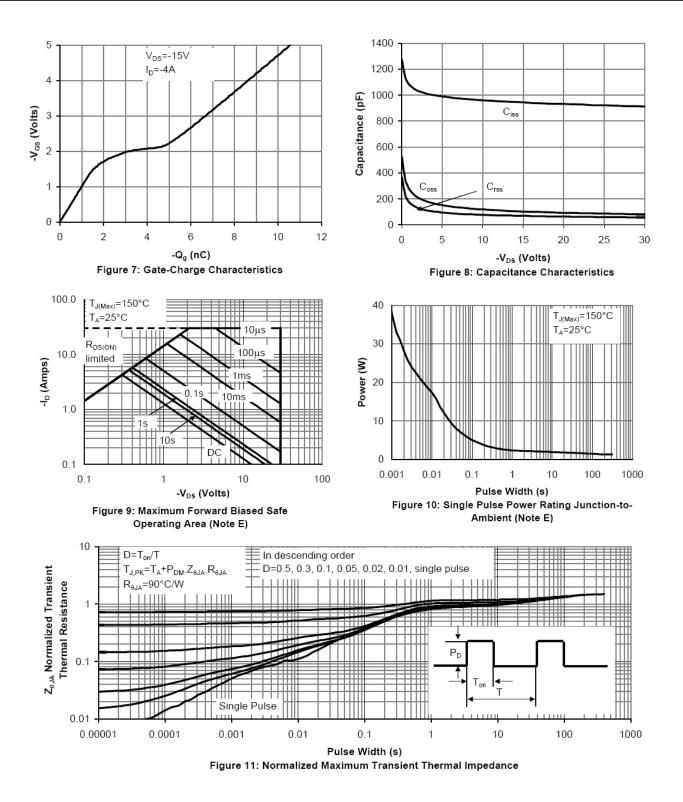
 2_{\times} Pulse width <300us , duty cycle <0.5%.



Typical Performance Characteristics

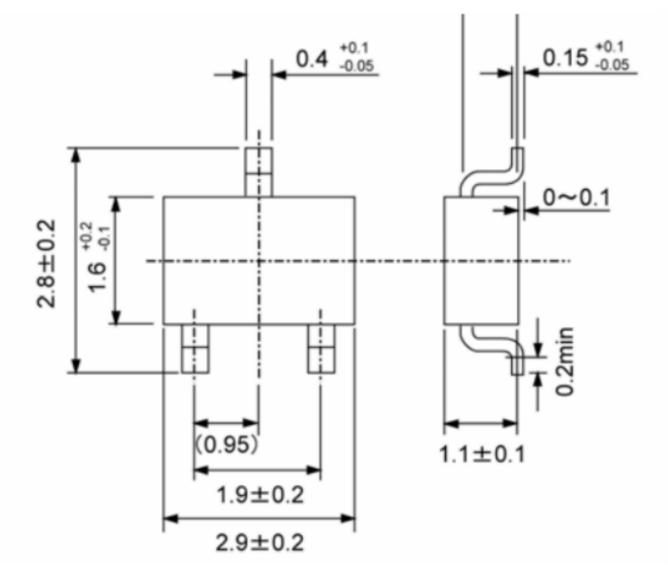








Package Information





- The information described herein is subject to change without notice.
- Nanjing Micro One Electronics Inc is not responsible for any problems caused by circuits or diagrams described herein whose related industrial properties, patents, or other rights belong to third parties. The application circuit examples explain typical applications of the products, and do not guarantee the success of any specific mass-production design.
- Use of the information described herein for other purposes and/or reproduction or copying without the express permission of Nanjing Micro One Electronics Inc is strictly prohibited.
- The products described herein cannot be used as part of any device or equipment affecting the human body, such as exercise equipment, medical equipment, security systems, gas equipment, or any apparatus installed in airplanes and other vehicles, without prior written permission of Nanjing Micro One Electronics Inc.
- Although Nanjing Micro One Electronics Inc exerts the greatest possible effort to ensure high quality and reliability, the failure or malfunction of semiconductor products may occur. The user of these products should therefore give thorough consideration to safety design, including redundancy, fire-prevention measures, and malfunction prevention, to prevent any accidents, fires, or community damage that may ensue.